										RE	VIS	IONS	3											
LTR							DES	CRIP	TION								DAT	E (YR	-MO-	DA)	, A	PPR	OVED	)
REV																								
SHEET																								
REV																								
SHEET		_L_	<u>L</u>		<u> </u>		L		<u> </u>							 L	L							L
REV STA		R	EV				_		<u> </u>	_		Ш				<u> </u>	L							
OF SHE		S	HEET		1	2	3	4	5	6	7	8	9	10		<u>L</u>	L		L	<u> </u>				
		RY	D		DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444  MICROCIRCUIT, DIGITAL, HIGH SPEED CMOS, HEX INVERTER, TTL COMPATIBLE, MONOLITHIC SILICON																			
THIS DRA FOR USE B AND A DEPART AMSC I	Y ALL I GENCIE MENT C	EPART	MEN HE	TS	24	AWIN	G AP	198	AL D				SIZE CAGE CODE A 67268 5962-89747  SHEET 1 OF 10			47								

DESC FORM 193 SEP 87

\* U.S. GOVERNMENT PRINTING OFFICE: 1987 — 748-129/60911

5962-E1419

DISTRIBUTION STATEMENT A. Approved for public release; distribution is unlimited.

1. SCOPE					
1.1 Scope. This drawing describes dewith 1.2.1 of MIL-STD-883, "Provisions for non-JAN devices".	ice requi or the use	rements f of MIL-S	or class B TD-883 in c	microcircu onjunction	uits in accordance with compliant
1.2 Part number. The complete part no	mber shal	l be as s	hown in the	following	g example:
5962-89747 01		-	C 	_	X 
Drawing number Device ty (1.2.1)			outline 2.2)		nish per  -38510
1.2.1 Device type. The device type sh	all ident	fy the c	ircuit func	tion as fo	llows:
Device type Generic nu	mber		Circu	it functio	<u>n</u>
01 54HCT 04					atible inputs
1.2.2 <u>Case outlines</u> . The case outline as follows:	s shall be	as desi	gnated in a	ppendix C	of MIL-M-38510, and
Outline letter			Case out	line	
C D-1 (14-1 2 C-2 (20-t	ead, .785" erminal, .	x .310" 358" x .:	x .200"), o	dual-in-li: '), square	ne package chip carrier package
1.3 Absolute maximum ratings. 1/				•	, , , , , , , , , , , , , , , , , , , ,
Supply voltage range DC input voltage range DC output voltage range DC output diode current (per pin) DC output diode current (per pin) DC v <sub>CC</sub> or GND current Storage temperature range Maximum power dissipation (P <sub>D</sub> ) Lead temperature (soldering, 10 second temperature) Lead temperature (T <sub>J</sub> )			-0.5 V dc -0.5 V dc +20 mA +20 mA +20 mA +50 mA -65 C to + 500 mW 2/ +300 C See MIL-M- +175 C	to V <sub>CC</sub> + ( to V <sub>CC</sub> + (	0.5 Y dc 0.5 Y dc
1.4 Recommended operating conditions.					
Supply voltage range ( $V_{CC}$ ) Case operating temperature range ( $T_{C}$ Input rise or fall time ( $t_r, t_f$ )		·	+4.5 V dc -55°C to + 0 to 500 n	to +5.5 V 125°C s	dc
1/ Unless otherwise specified, all volt 2/ For $T_C = +100^{\circ}C$ to $+125^{\circ}C$ , derate li					
STANDARDIZED	SIZE				
MILITARY DRAWING	Α			5	962-89747
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		RE	VISION LEVEL		SHEET 2
ESC FORM 193A					

DESC FORM 193A SEP 87

## 2. APPLICABLE DOCUMENTS

2.1 Government specification, standard, and bulletin. Unless otherwise specified, the following specification, standard, and bulletin of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein.

**SPECIFICATION** 

MIL TTARY

MIL-M-38510

- Microcircuits, General Specification for.

**STANDARD** 

**MILITARY** 

MIL-STD-883

- Test Methods and Procedures for Microelectronics.

BULLETIN

**MILITARY** 

MIL-BUL-103

- List of Standardized Military Drawings (SMD's).

(Copies of the specification, standard, and bulletin required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

- 2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.
  - 3. REQUIREMENTS
- 3.1 Item requirements. The individual item requirements shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein.
- 3.2 <u>Design, construction</u>, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein.
  - 3.2.1 <u>Terminal connections</u>. The terminal connections shall be as specified on figure 1.
  - 3.2.2 Truth table. The truth table shall be as specified on figure 2.
  - 3.2.4 Case outlines. The case outlines shall be in accordance with 1.2.2 herein.
- 3.3 <u>Electrical performance characteristics</u>. Unless otherwise specified herein, the electrical performance characteristics are as specified in table I and apply over the full case operating temperature range.
- 3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table II. The electrical tests for each subgroup are described in table I.
- $3.5\,$  Marking. Marking shall be in accordance with MIL-STD-883 (see 3.1 herein). The part shall be marked with the part number listed in 1.2 herein. In addition, the manufacturer's part number may also be marked as listed in MIL-BUL-103 (see 6.6 herein).

STANDARDIZED MILITARY DRAWING	SIZE A		5962-89747
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL	SHEET 3

DESC FORM 193A

**SEP 87** 

**★ U. S. GOVERNMENT PRINTING OFFICE: 1988---549-904** 

TABLE I. Electrical performance characteristics. Test Symbol Conditions Group A Limits Unit -55°C < T<sub>C</sub> < +125°C 1/ unless otherwise specified subgroups Min Max V<sub>CC</sub> = 4.5 V V<sub>IN</sub> = 2.0 V or 0.8 V High level output voltage VOH  $|I_0| = 20 \mu A | 1, 2, 3 |$ 4.4 ٧  $|I_0| = 4.0 \text{ mA}$ 3.7 Low level output voltage V<sub>CC</sub> = 4.5 V V<sub>IN</sub> = 2.0 V or 0.8 V VOL  $|I_0| = 20 \mu A$ 1, 2, 3 ٧ 0.1  $|I_0| = 4.0 \text{ mA}$ 0.4 High level input voltage VIH 2/ 1, 2, 3 2.0 ٧ Low level input voltage  $v_{\text{IL}}$ 2/ 1, 2, 3 ٧ 0.8  $V_{IN} = 0$  V,  $T_{C} = +25$ °C, see 4.3.1c Input capacitance CIN 4 10 рF  $V_{CC} = 5.5 \text{ V; } V_{IN} = V_{CC} \text{ or GND}$   $I_{OUT} = 0.0 \text{ Å}$ Quiescent current Icc 1, 2, 3 40 μА Input leakage current  $V_{CC} = 5.5 \text{ V; } V_{IN} = V_{CC} \text{ or GND}$ IIN 1, 2, 3 ±1.0  $\mu A$ Functional tests See 4.3.1d 7,8 Additional quiescent Any 1 input: V<sub>IN</sub> = 2.4 V or 0.5 V Other inputs: ΔICC 1, 2, 3 3.0 mΑ supply current VIN = V<sub>CC</sub> or GND I<sub>OUT</sub> = 0.0 A V<sub>CC</sub> = 5.5 V

See footnotes at end of table.

STANDARDIZED
MILITARY DRAWING
DEFENSE ELECTRONICS SUPPLY CENTER
DAYTON, OHIO 45444

SIZE
A
5962-89747

REVISION LEVEL
SHEET

DESC FORM 193A SEP 87

± U. S. GOVERNMENT PRINTING OFFICE: 1988—550-547

TABLE	I. Elect	trical performance characteristics -	Continued.			
Test	Symbol	Conditions 55°C 17	Group A	Lim	its	Unit
	<u> </u>	-55°C < T <sub>C</sub> < +125°C 1/ unless otherwise specified	subgroups	Min	Max	
Propagation delay time, A to Y	tpHL, tpLH	V <sub>CC</sub> = 4.5 V   C <sub>L</sub> = 50 pF   See figure 3	9 10, 11		   20   30	ns 
Transition time $3/$	t <sub>TLH</sub> , t <sub>THL</sub>		9 10, 11		15 22	ns

- For a power supply of 5 V  $\pm 10\%$ , the worst case output voltages (V<sub>OH</sub> and V<sub>OL</sub>) occur for HCT at 4.5 V. Thus, the 4.5 V values should be used when designing with this supply. Worst cases V<sub>IH</sub> and V<sub>IL</sub> occur at V<sub>CC</sub> = 5.5 V and 4.5 V respectively. The V<sub>IH</sub> and V<sub>IL</sub> tests are not required and shall be applied as forcing functions for the V<sub>OH</sub> or V<sub>OL</sub> tests.
- 3/ Transition time ( $t_{TLH}$ ,  $t_{THL}$ ), if not tested, shall be guaranteed to the specified limits.
- 3.6 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-BUL-103 (see 6.6 herein). The certificate of compliance submitted to DESC-ECS prior to listing as an approved source of supply shall affirm that the manufacturer's product meets the requirements of MIL-STD-883 (see 3.1 herein) and the requirements herein.
- 3.7 Certificate of conformance. A certificate of conformance as required in MIL-STD-883 (see 3.1 herein) shall be provided with each lot of microcircuits delivered to this drawing.
- 3.8 Notification of change. Notification of change to DESC-ECS shall be required in accordance with MIL-STD-883 (see 3.1 herein).
- 3.9 <u>Verification and review</u>. DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.
  - 4. QUALITY ASSURANCE PROVISIONS
- 4.1 <u>Sampling and inspection</u>. Sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein).
- 4.2 <u>Screening.</u> Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:
  - a. Burn-in test, method 1015 of MIL-STD-883.
    - (1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.6 herein).
    - (2)  $T_A = +125^{\circ}C$ , minimum.
  - b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

STANDARDIZED MILITARY DRAWING	SIZE <b>A</b>		5	962-89747	
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL		SHEET	5

DESC FORM 193A **SEP 87** 

★ U. S. GOVERNMENT PRINTING OFFICE: 1988--550-647

Device type	0	1
Case outlines	С	2
Terminal number	Termina	l symbol
1	1A	l NC
2 3 4 5 6 7 8	1A 1Y	1A
3	2A 2Y 3A	I IY
4 (	<b>ZY</b>	ļ 2A
5	<u>3A</u>	NC NC
<u>6</u>	37	<u> 2</u> Y
7 !	GND	NC NC
8	47	<u>3A</u>
	<u>4A</u>	37
10	<u>5</u> Y	GND
11	<u>5A</u>	l <u>nc</u>
12	<u>67</u>	4 <del>Y</del>
13	6A	<u>4A</u>
14   15	v <sub>cc</sub>	57
16		NC
17		5A
18		NC EV
19		5Y 6A
20		VCC

NC = No connection

FIGURE 1. Terminal connections

Input A	Ou <u>t</u> put Y
н	L
<u> </u>	<u> </u> н

FIGURE 2. Truth table.

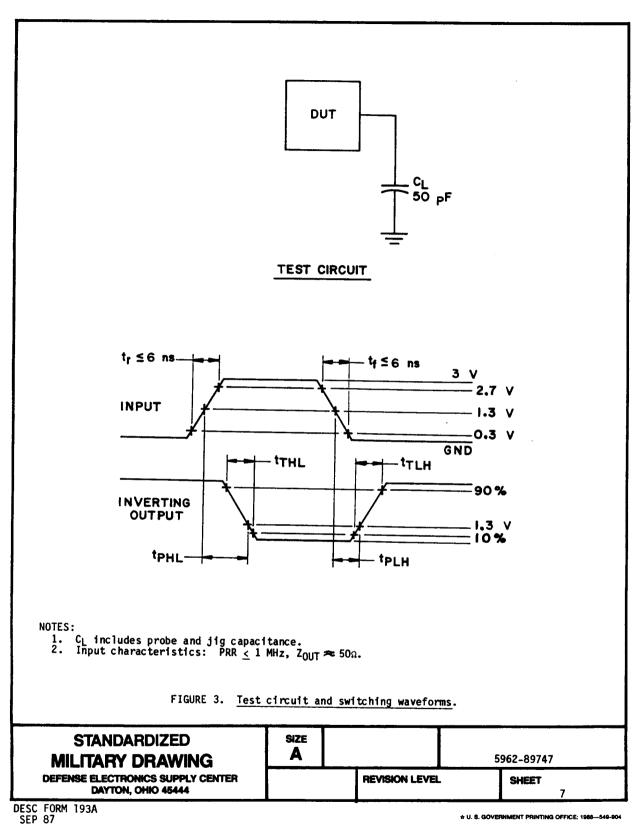
STANDARDIZED
MILITARY DRAWING
DEFENSE ELECTRONICS SUPPLY CENTER
DAYTON, OHIO 45444

SIZE
A
5962-89747

REVISION LEVEL
SHEET 6

DESC FORM 193A SEP 87

# U. S. GOVERNMENT PRINTING OFFICE: 1988—850-547



★ U. S. GOVERNMENT PRINTING OFFICE: 1988--549-904

## TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (per method 5005, table I)
  Interim electrical parameters   (method 5004)	
  Final electrical test parameters   (method 5004)	   1*, 2, 3, 7,
  Group A test requirements   (method 5005)	   1, 2, 3, 4, 7,
  Groups C and D end-point   electrical parameters   (method 5005)	1, 2, 3

- PDA applies to subgroup 1. Subgroups 10 and 11, if not tested, shall be guaranteed to the specified limits in table I.
- 4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.
  - 4.3.1 Group A inspection.
    - a. Tests shall be as specified in table II herein.
    - b. Subgroups 5 and 6 in table I, method 5005 of MIL-STD-883 shall be omitted.
    - c. Subgroup 4 ( $C_{IN}$  measurement) shall be measured only for the initial test and after process or design changes which may affect capacitance. Test all applicable pins on five devices with zero failures.
    - d. Subgroups 7 and 8 tests shall verify the truth table as specified on figure 2.
  - 4.3.2 Groups C and D inspections.
    - a. End-point electrical parameters shall be as specified in table II herein.
    - b. Steady-state life test conditions, method 1005 of MIL-STD-883.
      - (1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.6 herein).
      - (2)  $T_A = +125^{\circ}C$ , minimum.
      - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

STANDARDIZED MILITARY DRAWING	SIZE A		59	962-89747	
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL	•	SHEET 8	

DESC FORM 193A SEP 87

# U. S. GOVERNMENT PRINTING OFFICE: 1968--550-547

- 5. PACKAGING
- 5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-M-38510.
  - 6. NOTES
- 6.1 <u>Intended use.</u> Microcircuits conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for OEM application. When a military specification exists and the product covered by this drawing has been qualified for listing on QPL-38510, the device specified herein will be inactivated and will not be used for new design. The QPL-38510 product shall be the preferred item
- 6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
- 6.3 <u>Configuration control of SMD</u>'s. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished in accordance with MIL-STD-481 using DD Form 1693, Engineering Change Proposal (Short Form).
- 6.4 Record of users. Military and industrial users shall inform Defense Electronics Supply Center when a system application requires configuration control and the applicable SMD. DESC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronics devices (FSC 5962) should contact DESC-ECS, telephone (513) 296-6022.
- 6.5 <u>Comments</u>. Comments on this drawing should be directed to DESC-ECS, Dayton, Ohio 45444, or telephone (513) 296-5375.

STANDARDIZED MILITARY DRAWING	SIZE A		5962-89747	
DEFENSE ELECTRONICS SUPPLY CENTER DAYTON, OHIO 45444		REVISION LEVEL	SHEET 9	

DESC FORM 193A SEP 87

± U. S. GOVERNMENT PRINTING OFFICE: 1988—550-547

6.6 Approved sources of supply. Approved sources of supply are listed in MIL-BUL-103.
Additional sources will be added to MIL-BUL-103 as they become available. The vendors listed in MIL-BUL-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DESC-ECS. The approved sources of supply listed below are for information purposes only and are current only to the date of the last action of this document.

Military drawing part number	Vendor   CAGE   number	Vendor   similar part   number <u>1</u> /
5962-8974701CX	   18714   01295	CD54HCT04F/3A SnJ54HCT04J
5962-89747012X	01295	SNJ 54HCTO4FK

1/ Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

Vendor CAGE
number

18714

RCA Corporation
Semiconductor Sector
Route 202
Somerville, NJ 08876

Texas Instruments Incorporated
P.O. Box 60448
Midland, TX 79711-0448

STANDARDIZED
MILITARY DRAWING
DEFENSE ELECTRONICS SUPPLY CENTER

DAYTON, OHIO 45444

SIZE A 5962-89747

REVISION LEVEL SHEET 10

DESC FORM 193A SEP 87

**☆ U. B. GOVERNMENT PRINTING OFFICE: 1988--550-547** 

018053 \_ \_ \_